

### • General Description

The AGM1095M combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

### • Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

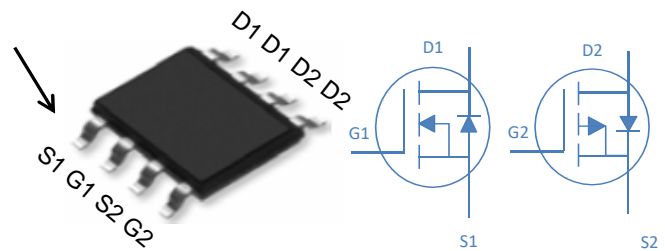
### • Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

### Product Summary

BVDSS	RDSON	ID
100V	100mΩ	7A
-100V	240mΩ	-6A

### SOP8 Pin Configuration



### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM1095M	AGM1095M	SOP8	---	---	3000

Table 1. Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ )

Symbol	Parameter	Rating		Units
		N-Ch	P-Ch	
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	100	-100	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	$\pm 20$	V
ID	Drain Current-Continuous( $T_A=25^\circ\text{C}$ ) (Note 1)	7.0	-6.0	A
	Drain Current-Continuous( $T_A=100^\circ\text{C}$ )	4.2	-3.6	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	28	-24.5	A
$P_D$	Total Power Dissipation( $T_A=25^\circ\text{C}$ )	2.5	2.5	W
EAS	Avalanche energy (Note 3)	90	110	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	-55 To 150	$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>	--	50	$^\circ\text{C/W}$

**Table 3. N- Channel Electrical Characteristics (TA=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	100	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=100V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	1.0	--	2.1	V
gFS	Forward Transconductance	VDS=5V,ID=3A	--	7	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=6A	--	100	120	mΩ
		VGS=4.5V, ID=3A	--	102	140	mΩ
<b>Dynamic Characteristics</b>						
Ciss	Input Capacitance	VDS=50V,VGS=0V, F=1MHZ	--	999	--	pF
Coss	Output Capacitance		--	46	--	pF
Crss	Reverse Transfer Capacitance		--	32	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	--	--	Ω
<b>Switching Times</b>						
td(on)	Turn-on Delay Time	VGS=10V,VDS=30V, RL=15Ω,RGEN=2.5Ω	--	50	--	nS
tr	Turn-on Rise Time		--	2.9	--	nS
td(off)	Turn-Off Delay Time		--	17.3	--	nS
tf	Turn-Off Fall Time		--	2.8	--	nS
Qg	Total Gate Charge	VGS=10V, VDS=30V, ID=3A	--	25.4	--	nC
Qgs	Gate-Source Charge		--	4.2	--	nC
Qgd	Gate-Drain Charge		--	4.3	--	nC
<b>Source-Drain Diode Characteristics</b>						
ISD	Source-Drain Current(Body Diode)		--	--	7.0	A
VSD	Forward on Voltage	VGS=0V,IS=6A	--	--	1.2	V
trr	Reverse Recovery Time	IF=3A , dI/dt=100A/μs ,	--	--	--	ns
Qrr	Reverse Recovery Charge	TJ=25°C	--	--	--	nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25°C

**Table 3. P-Channel Electrical Characteristics (TA=25°C unless otherwise noted)**

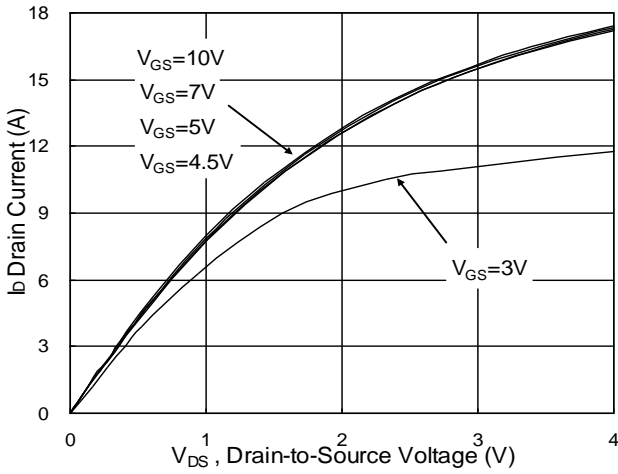
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-100	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-100V, VGS=0V	--	--	-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V, VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=-250μA	-1.2	-1.6	-2.1	V
gFS	Forward Transconductance	VDS=-5V, ID=-3A	--	8	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-6A	--	240	250	mΩ
		VGS=-4.5V, ID=-3A	--	230	250	mΩ
<b>Dynamic Characteristics</b>						
Ciss	Input Capacitance	VDS=-50V, VGS=0V, F=1MHZ	--	1600	--	pF
Coss	Output Capacitance		--	86	--	pF
Crss	Reverse Transfer Capacitance		--	40	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V, f=1.0MHz	--	1.2	--	Ω
<b>Switching Times</b>						
td(on)	Turn-on Delay Time	VGS=-10V, VDS=-50V, ID=-10A, RGEN=3.3Ω	--	12	--	nS
tr	Turn-on Rise Time		--	152	--	nS
td(off)	Turn-Off Delay Time		--	28	--	nS
tf	Turn-Off Fall Time		--	38	--	nS
Qg	Total Gate Charge	VGS=-10V, VDS=-50V, ID=-4A	--	33	--	nC
Qgs	Gate-Source Charge		--	4.3	--	nC
Qgd	Gate-Drain Charge		--	7.2	--	nC
<b>Source-Drain Diode Characteristics</b>						
ISD	Source-Drain Current(Body Diode)		--	--	-6.0	A
VSD	Forward on Voltage	VGS=0V, IS=-6A	--	--	-1.2	V
trr	Reverse Recovery Time	IF=-4A , di/dt=100A/μs , TJ=25°C	--	--	--	ns
Qrr	Reverse Recovery Charge		--	--	--	nc

Notes 1.The maximum current rating is package limited.

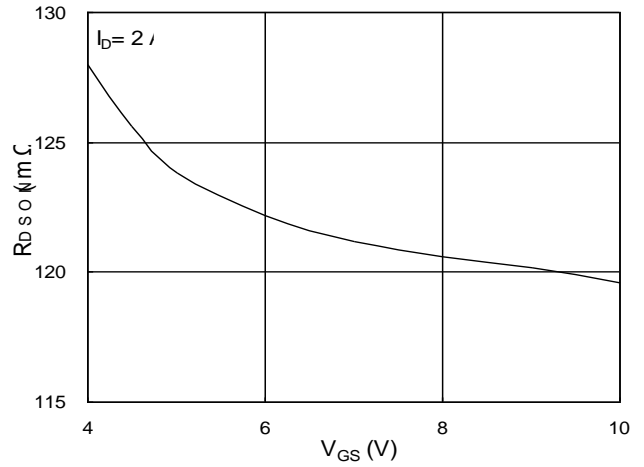
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature Notes

3.EAS condition: TJ=25°C

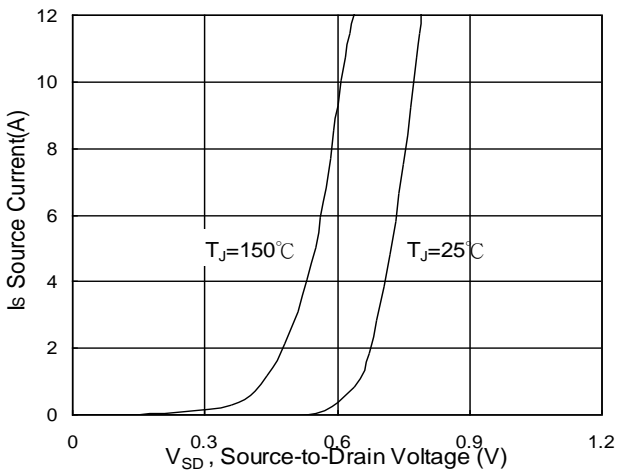
**N- Channel 100V MOSFET**



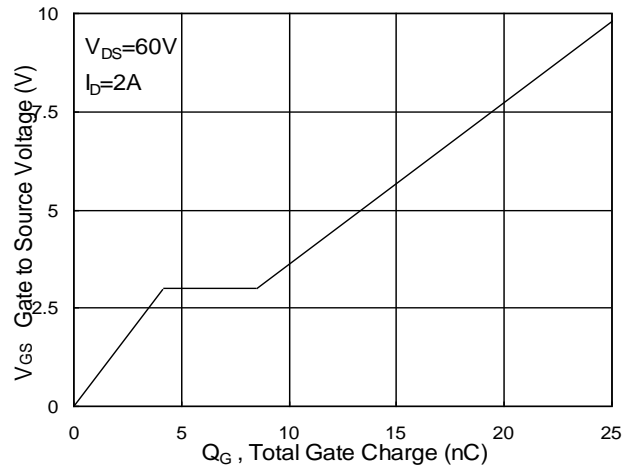
**Fig.1 Typical Output Characteristics**



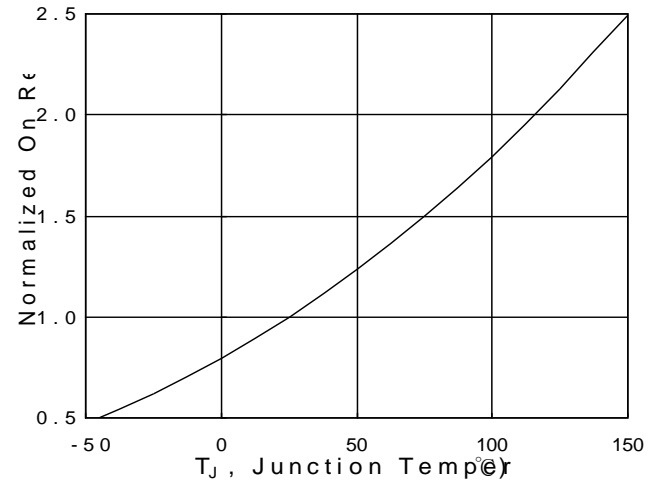
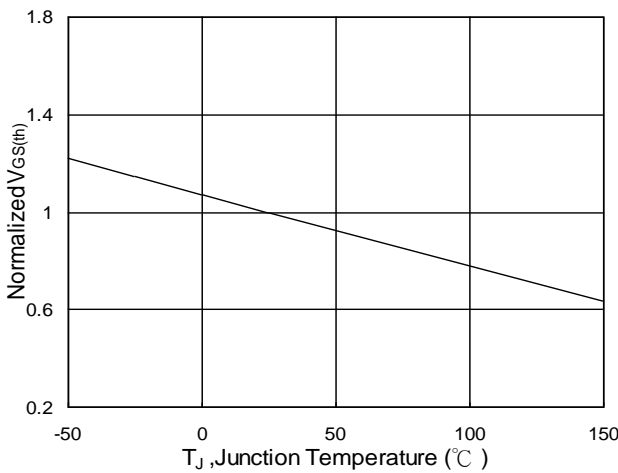
**Fig.2 On-Resistance vs. Gate-Source**



**Fig.3 Forward Characteristics Of Reverse**



**Fig.4 Gate-Charge Characteristics**



### N- Channel 100V MOSFET

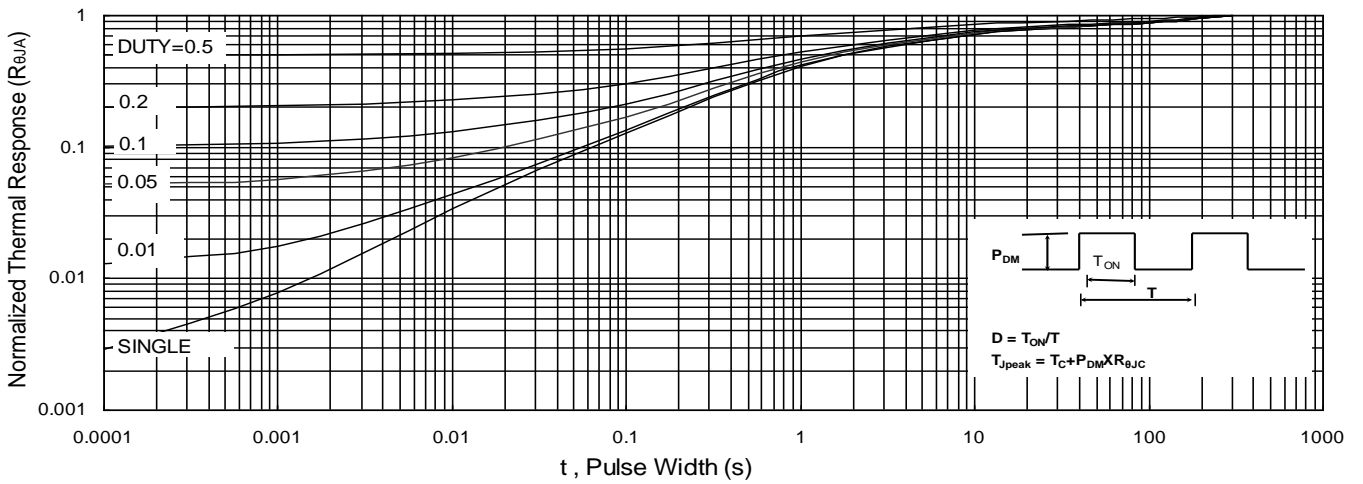
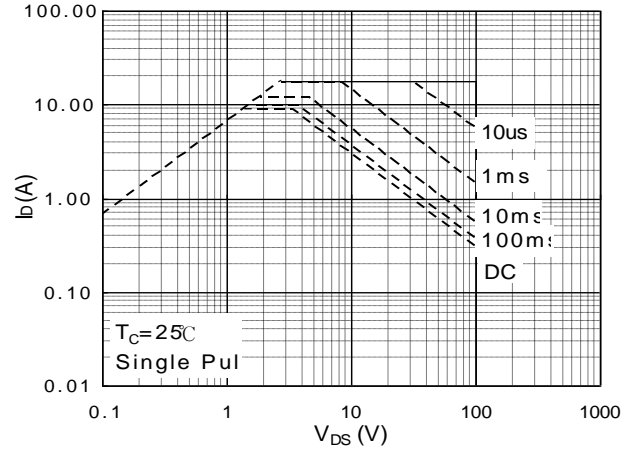
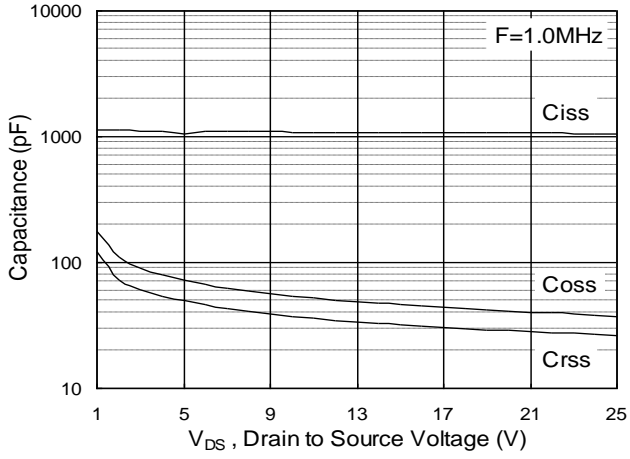
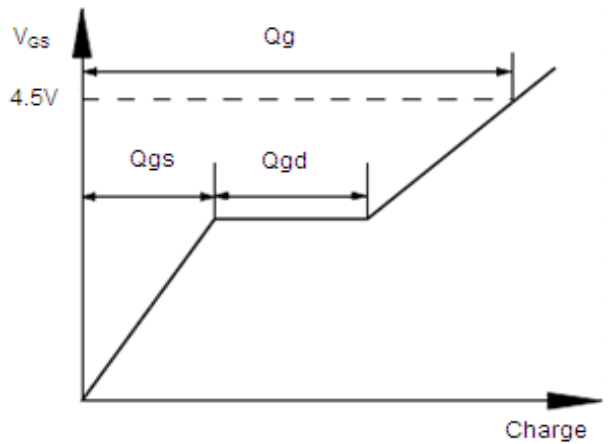
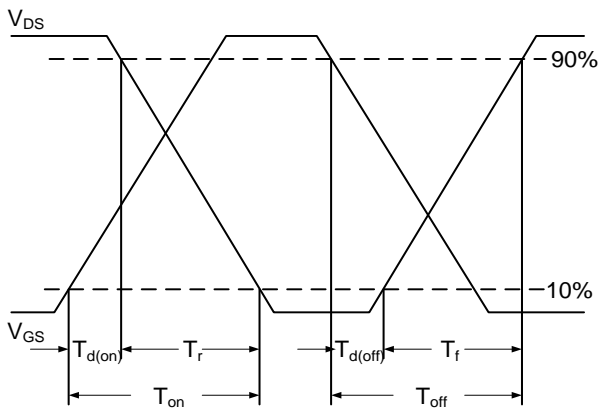


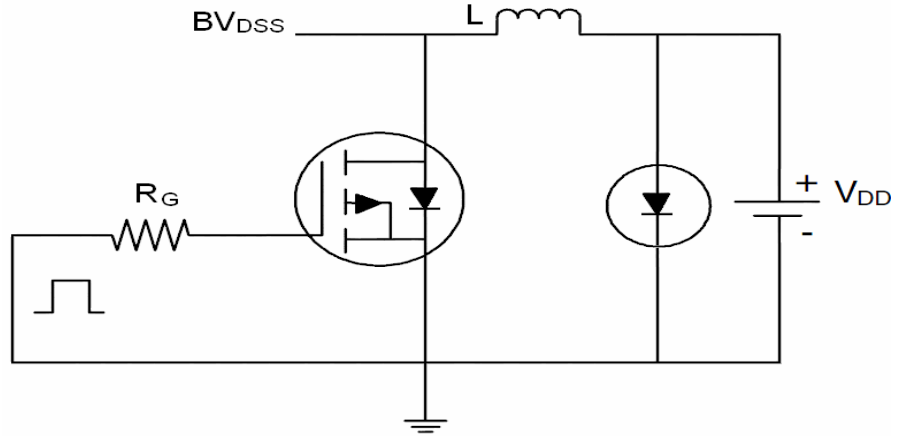
Fig.9 Normalized Maximum Transient Thermal Impedance



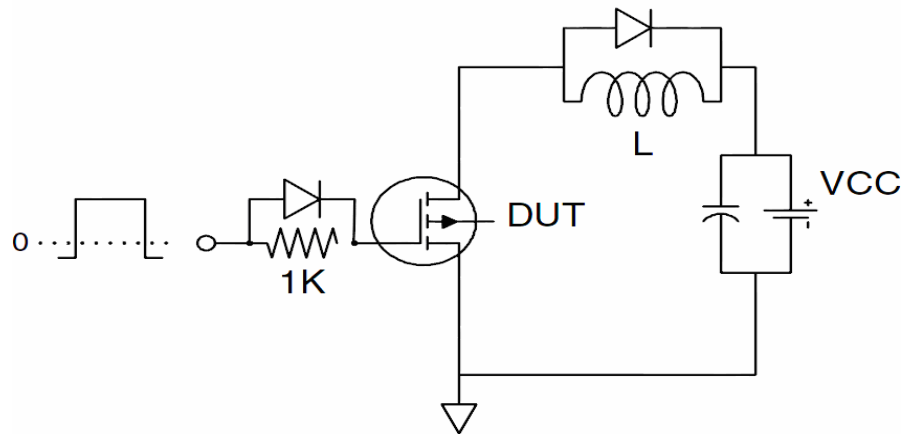
**P- Channel 100V MOSFET**

**Test Circuit**

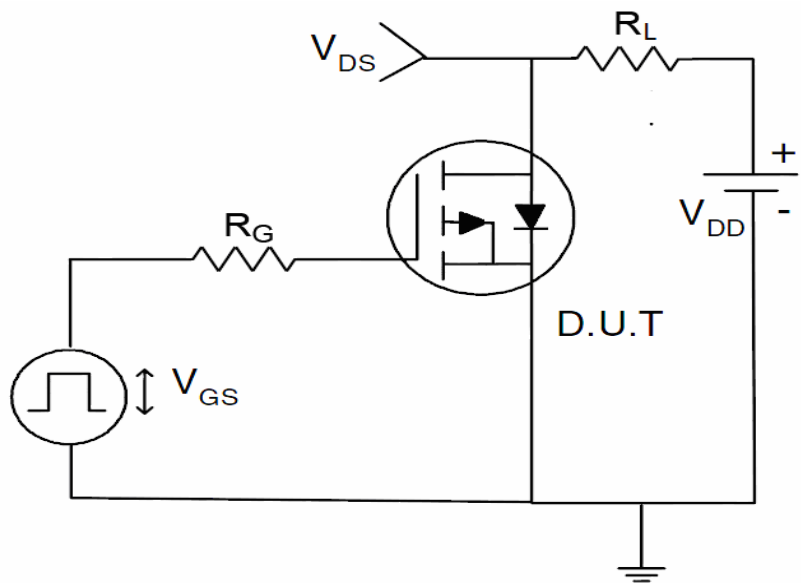
**1)  $E_{AS}$  Test Circuit**



**2) Gate Charge Test Circuit**



**3) Switch Time Test Circuit**



P- Channel 100V MOSFET

Typical Electrical and Thermal Characteristics (Curves)

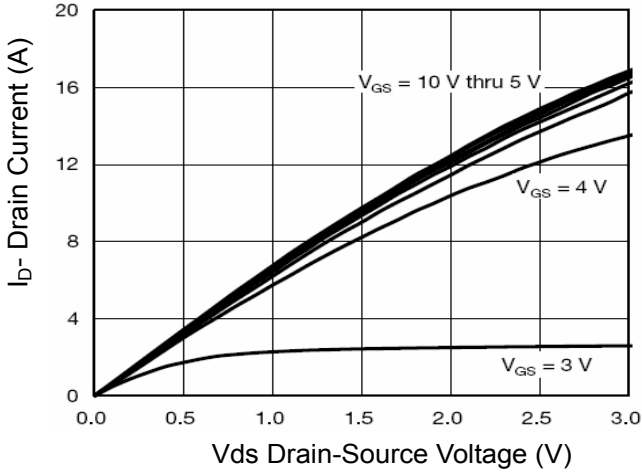


Figure 1 Output Characteristics

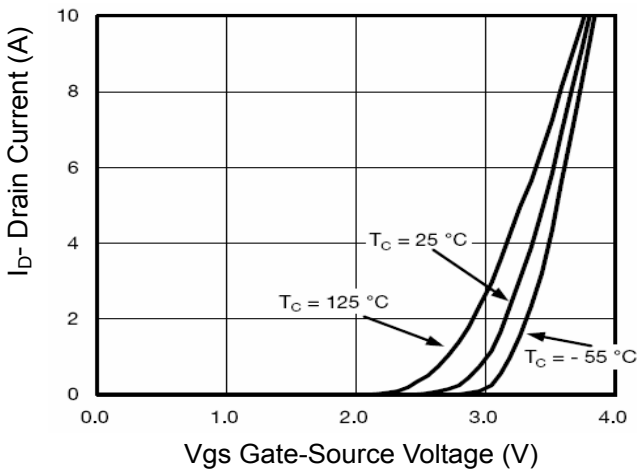


Figure 2 Transfer Characteristics

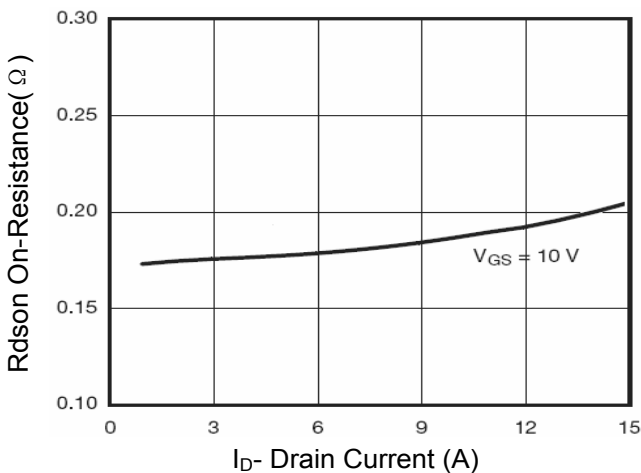


Figure 3 Rdson- Drain Current

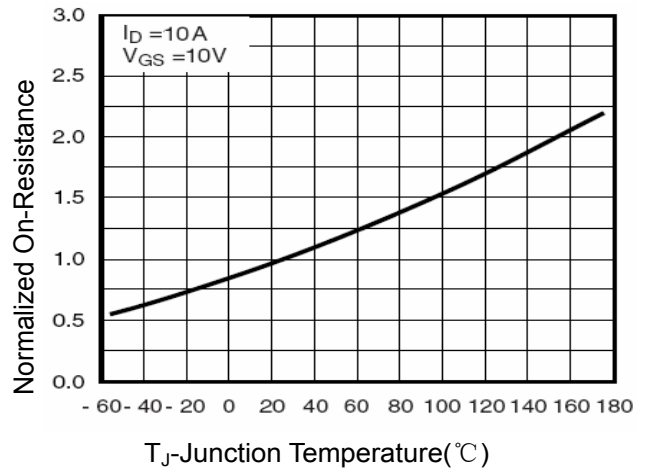


Figure 4 Rdson-Junction Temperature

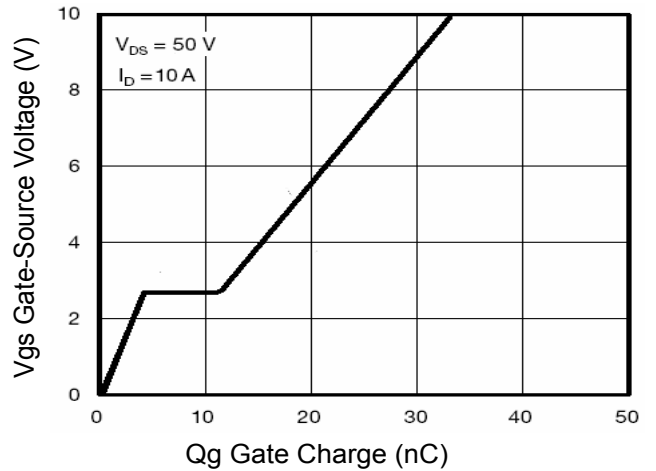


Figure 5 Gate Charge

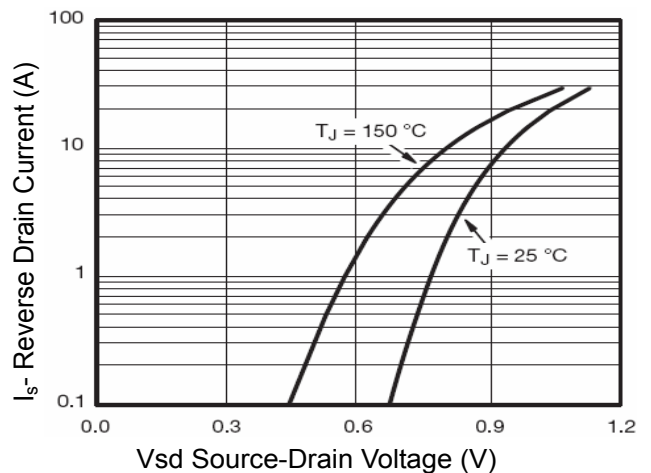
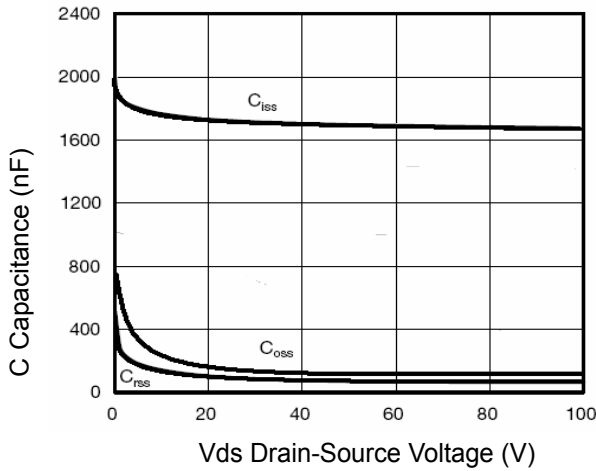
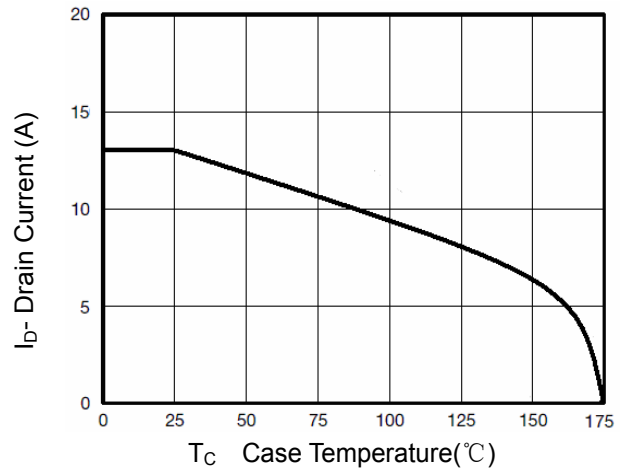
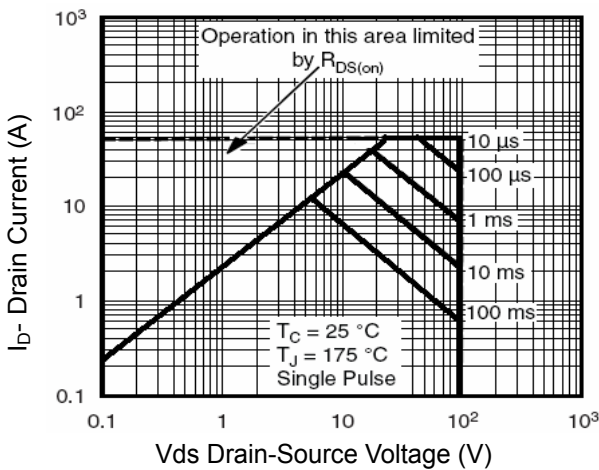
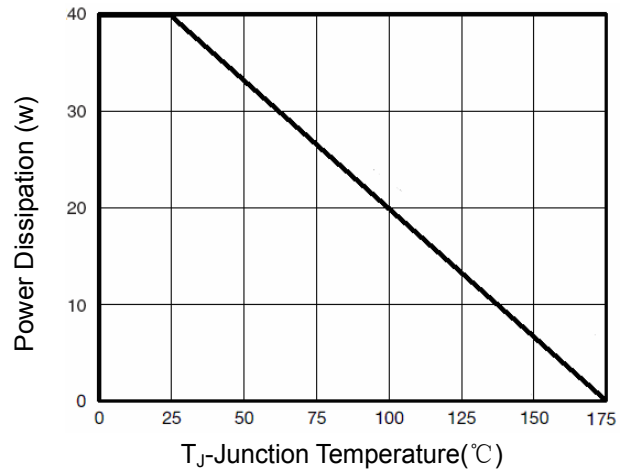
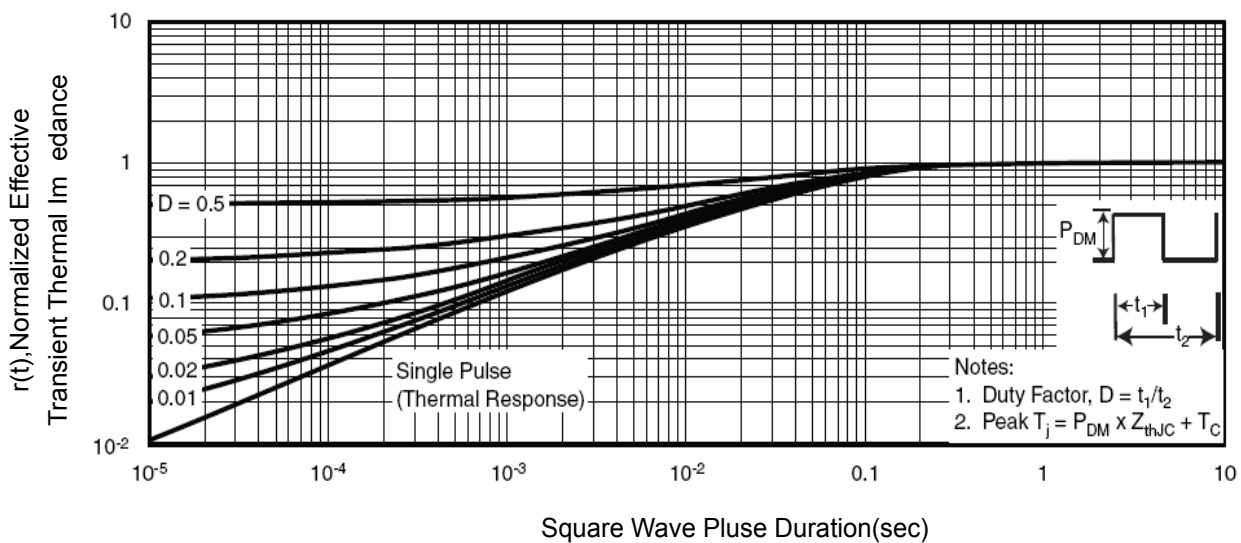


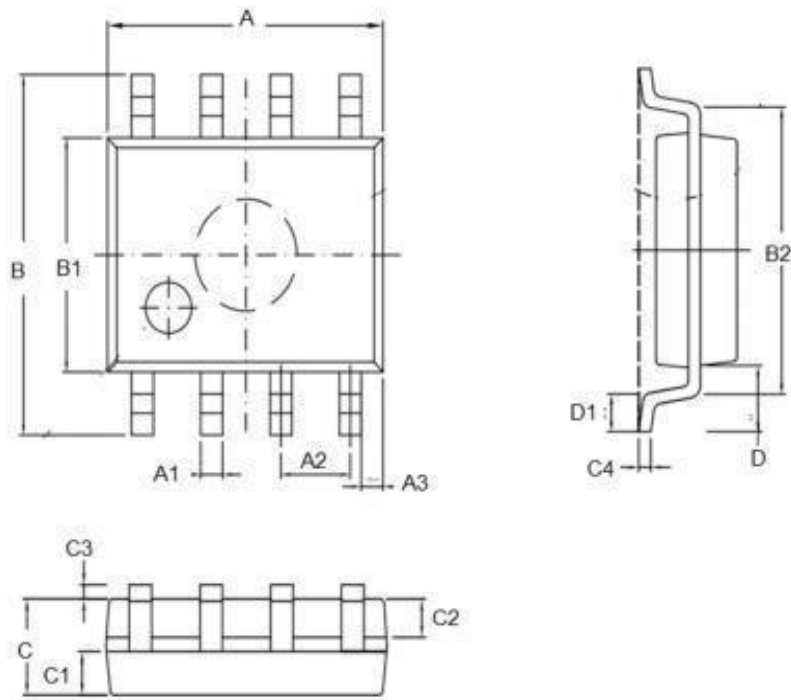
Figure 6 Source- Drain Diode Forward

**P- Channel 100V MOSFET**

**Figure 7 Capacitance vs Vds**

**Figure 9 Drain Current vs Case Temperature**

**Figure 8 Safe Operation Area**

**Figure 10 Power De-rating**

**Figure 11 Normalized Maximum Transient Thermal Impedance**



**•Dimensions(SOP8)**

SYMBOL	min	TYP	max	SYMBOL	min		max
A	4.80		5.00	C	1.30		1.50
A1	0.37		0.47	C1	0.55		0.75
A2		1.27		C2	0.55		0.65
A3		0.41		C3	0.05		0.20
B	5.80		6.20	C4	0.19	0.20	0.23
B1	3.80		4.00	D		1.05	
B2		5.00		D1	0.40		0.62




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